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and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Hitoshi HABUKA

Additional name(s) of conveying party(ies) attached? ☒ No

2. Name and address of receiving party(ies):

Name: Shin-Etsu Handotai Co., Ltd.

St. Address: 4-2, Marunouchi 1 chome

City: Chiyoda-ku

State: Tokyo Country: Japan

Additional name(s) & address(es) attached? Yes ☒ No

3. Nature of conveyance:

☒ Assignment

Merger

Security Agreement

Change of Name

Other:

Execution Date: October 14, 1998

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application Serial No.

B. Patent No.(s)

09/142,494

*

*

09/142494

Additional numbers attached? Yes ☐ No ☒

5. Name and address of party to whom correspondence concerning document should be mailed:

Ronald R. Snider

P.O. Box 27613

Washington, D.C. 20038-7613

(202-347-2600)

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

☒ Enclosed☒ Authorized to be charged to deposit account if any error.

8. Deposit account number:

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Ronald R. SniderName of Person Signing
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SignatureDecember 18, 1998_____
Date

Total number of pages comprising cover sheet, attachments and document: 2

Mail documents to be recorded with required cover sheet information to:

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Box Assignments
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PAT-153P

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:
SILICON SINGLE CRYSTAL AND METHOD FOR FABRICATING SILICON SINGLE CRYSTAL
THIN FILM
(Title of Invention)
for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on _____, 19 _____ (Serial No. _____); and

WHEREAS, Shin-Etsu Handotai Co., Ltd.

a corporation of Japan (Full Name of Assignee)

whose post office address is 4-2, Marunouchi 1 chome, Chiyoda-ku, Tokyo, Japan
(Country of Incorporation)
(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/We, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

1. FULL NAME OF SOLE OR FIRST ASSIGNOR <u>Hitoshi HABUKA</u>	ASSIGNOR'S SIGNATURE <u>Hitoshi Habuka</u>	DATE <u>Oct. 14 1998</u>
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